

PATENT ASSIGNMENT

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NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
E. Todd Ryan	01/08/2008
RECEIVING PARTY DATA	
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PROPERTY NUMBERS Total: 1	
Property Type	Number
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CH \$40.00 11972175

ASSIGNMENT

Docket No. YOR920070653US1

Whereas, we

INVENTOR
AND CITY

(1) **E. Todd Ryan**
County of **Saratoga**

of Clifton Park,
and State of New York,

have invented certain improvements in

TITLE

ADVANCED LOW K CAP FILM FORMATION PROCESS FOR NANO ELECTRONIC DEVICES

DATES THAT
INVENTORS
SIGNED THE
DECLARATION

and executed, respectively, a United States patent application therefor on

(1) 1/8/08, 2008

Whereas, Advanced Micro Devices, Inc., a corporation of Delaware, having a place of business at Austin, Texas 78741, desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we, the above named, hereby sell, assign, and transfer to Advanced Micro Devices, Inc., its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and in all foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to Advanced Micro Devices, Inc., its successors and assigns; and we hereby agree that Advanced Micro Devices, Inc. may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by Advanced Micro Devices, Inc.

Signed and sealed

E. Todd Ryan
E. Todd Ryan

on 1/8/08, 2008

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